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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

| | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 317000 |
| Number of Logic Elements/Cells | 840000 |
| Total RAM Bits | 53248000 |
| Number of I/O | 600 |
| Number of Gates | - |
| Voltage - Supply | 0.87V ~ 0.93V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 1760-BBGA, FCBGA |
| Supplier Device Package | 1760-HBGA (45x45) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/5sgxmb9r2h43c2n |

Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering^{(1), (2), (3)} (Part 2 of 2)

| Transceiver Speed Grade | Core Speed Grade | | | | | | | |
|--------------------------|------------------|---------|-----|-----|---------|---------|--------------------|-----|
| | C1 | C2, C2L | C3 | C4 | I2, I2L | I3, I3L | I3YY | I4 |
| 3 GX channel—8.5 Gbps | — | Yes | Yes | Yes | — | Yes | Yes ⁽⁴⁾ | Yes |

Notes to Table 1:

- (1) C = Commercial temperature grade; I = Industrial temperature grade.
- (2) Lower number refers to faster speed grade.
- (3) C2L, I2L, and I3L speed grades are for low-power devices.
- (4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices.

Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering^{(1), (2)}

| Transceiver Speed Grade | Core Speed Grade | | | |
|--|------------------|-----|-----|-----|
| | C1 | C2 | I2 | I3 |
| 2 GX channel—12.5 Gbps GT channel—28.05 Gbps | Yes | Yes | — | — |
| 3 GX channel—12.5 Gbps GT channel—25.78 Gbps | Yes | Yes | Yes | Yes |

Notes to Table 2:

- (1) C = Commercial temperature grade; I = Industrial temperature grade.
- (2) Lower number refers to faster speed grade.

Absolute Maximum Ratings

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

Table 3. Absolute Maximum Ratings for Stratix V Devices (Part 1 of 2)

| Symbol | Description | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V _{CC} | Power supply for core voltage and periphery circuitry | -0.5 | 1.35 | V |
| V _{CCPT} | Power supply for programmable power technology | -0.5 | 1.8 | V |
| V _{CCPGM} | Power supply for configuration pins | -0.5 | 3.9 | V |
| V _{CC_AUX} | Auxiliary supply for the programmable power technology | -0.5 | 3.4 | V |
| V _{CCBAT} | Battery back-up power supply for design security volatile key register | -0.5 | 3.9 | V |
| V _{CCPD} | I/O pre-driver power supply | -0.5 | 3.9 | V |
| V _{CCIO} | I/O power supply | -0.5 | 3.9 | V |

Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 2 of 2)

| Symbol | Description | Conditions | Resistance Tolerance | | | | Unit |
|---------------------|--|----------------------------|-----------------------------|---------------|-------------------------|---------------|-------------|
| | | | C1 | C2, I2 | C3, I3, I3YY | C4, I4 | |
| 50- Ω R_S | Internal series termination without calibration (50- Ω setting) | $V_{CCIO} = 1.8$ and 1.5 V | ± 30 | ± 30 | ± 40 | ± 40 | % |
| 50- Ω R_S | Internal series termination without calibration (50- Ω setting) | $V_{CCIO} = 1.2$ V | ± 35 | ± 35 | ± 50 | ± 50 | % |
| 100- Ω R_D | Internal differential termination (100- Ω setting) | $V_{CCPD} = 2.5$ V | ± 25 | ± 25 | ± 25 | ± 25 | % |

Calibration accuracy for the calibrated series and parallel OCTs are applicable at the moment of calibration. When voltage and temperature conditions change after calibration, the tolerance may change.

OCT calibration is automatically performed at power-up for OCT-enabled I/Os. Table 13 lists the OCT variation with temperature and voltage after power-up calibration. Use Table 13 to determine the OCT variation after power-up calibration and Equation 1 to determine the OCT variation without recalibration.

Equation 1. OCT Variation Without Recalibration for Stratix V Devices (1), (2), (3), (4), (5), (6)

$$R_{OCT} = R_{SCAL} \left(1 + \langle \frac{dR}{dT} \times \Delta T \rangle \pm \langle \frac{dR}{dV} \times \Delta V \rangle \right)$$

Notes to Equation 1:

- (1) The R_{OCT} value shows the range of OCT resistance with the variation of temperature and V_{CCIO} .
- (2) R_{SCAL} is the OCT resistance value at power-up.
- (3) ΔT is the variation of temperature with respect to the temperature at power-up.
- (4) ΔV is the variation of voltage with respect to the V_{CCIO} at power-up.
- (5) dR/dT is the percentage change of R_{SCAL} with temperature.
- (6) dR/dV is the percentage change of R_{SCAL} with voltage.

Table 13 lists the on-chip termination variation after power-up calibration.

Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 1 of 2)⁽¹⁾

| Symbol | Description | V_{CCIO} (V) | Typical | Unit |
|---------------|--|----------------------------------|----------------|-------------|
| dR/dV | OCT variation with voltage without recalibration | 3.0 | 0.0297 | %/mV |
| | | 2.5 | 0.0344 | |
| | | 1.8 | 0.0499 | |
| | | 1.5 | 0.0744 | |
| | | 1.2 | 0.1241 | |

Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 2 of 2)

| I/O Standard | V _{IL(DC)} (V) | | V _{IH(DC)} (V) | | V _{IL(AC)} (V) | V _{IH(AC)} (V) | V _{OL} (V) | V _{OH} (V) | I _{ol} (mA) | I _{oh} (mA) |
|------------------|-------------------------|-------------------------|-------------------------|--------------------------|-------------------------|-------------------------|---------------------|-------------------------|----------------------|----------------------|
| | Min | Max | Min | Max | Max | Min | Max | Min | | |
| HSTL-18 Class I | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 8 | -8 |
| HSTL-18 Class II | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 16 | -16 |
| HSTL-15 Class I | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 8 | -8 |
| HSTL-15 Class II | — | V _{REF} – 0.1 | V _{REF} + 0.1 | — | V _{REF} – 0.2 | V _{REF} + 0.2 | 0.4 | V _{CCIO} – 0.4 | 16 | -16 |
| HSTL-12 Class I | -0.15 | V _{REF} – 0.08 | V _{REF} + 0.08 | V _{CCIO} + 0.15 | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.25* | V _{CCIO} | 8 | -8 |
| HSTL-12 Class II | -0.15 | V _{REF} – 0.08 | V _{REF} + 0.08 | V _{CCIO} + 0.15 | V _{REF} – 0.15 | V _{REF} + 0.15 | 0.25* | V _{CCIO} | 16 | -16 |
| HSUL-12 | — | V _{REF} – 0.13 | V _{REF} + 0.13 | — | V _{REF} – 0.22 | V _{REF} + 0.22 | 0.1* | V _{CCIO} | 0.9* | — |

Table 20. Differential SSTL I/O Standards for Stratix V Devices

| I/O Standard | V _{CCIO} (V) | | | V _{SWING(DC)} (V) | | V _{X(AC)} (V) | | | V _{SWING(AC)} (V) | |
|----------------------|-----------------------|------|-------|----------------------------|-------------------------|------------------------------|----------------------|------------------------------|--|--|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Max |
| SSTL-2 Class I, II | 2.375 | 2.5 | 2.625 | 0.3 | V _{CCIO} + 0.6 | V _{CCIO} /2 – 0.2 | — | V _{CCIO} /2 + 0.2 | 0.62 | V _{CCIO} + 0.6 |
| SSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.25 | V _{CCIO} + 0.6 | V _{CCIO} /2 – 0.175 | — | V _{CCIO} /2 + 0.175 | 0.5 | V _{CCIO} + 0.6 |
| SSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.2 | (1) | V _{CCIO} /2 – 0.15 | — | V _{CCIO} /2 + 0.15 | 0.35 | — |
| SSTL-135 Class I, II | 1.283 | 1.35 | 1.45 | 0.2 | (1) | V _{CCIO} /2 – 0.15 | V _{CCIO} /2 | V _{CCIO} /2 + 0.15 | 2(V _{IH(AC)} – V _{REF}) | 2(V _{IL(AC)} – V _{REF}) |
| SSTL-125 Class I, II | 1.19 | 1.25 | 1.31 | 0.18 | (1) | V _{CCIO} /2 – 0.15 | V _{CCIO} /2 | V _{CCIO} /2 + 0.15 | 2(V _{IH(AC)} – V _{REF}) | — |
| SSTL-12 Class I, II | 1.14 | 1.2 | 1.26 | 0.18 | — | V _{REF} – 0.15 | V _{CCIO} /2 | V _{REF} + 0.15 | -0.30 | 0.30 |

Note to Table 20:

- (1) The maximum value for V_{SWING(DC)} is not defined. However, each single-ended signal needs to be within the respective single-ended limits (V_{IH(DC)} and V_{IL(DC)}).

Table 21. Differential HSTL and HSUL I/O Standards for Stratix V Devices (Part 1 of 2)

| I/O Standard | V _{CCIO} (V) | | | V _{DIF(DC)} (V) | | V _{X(AC)} (V) | | | V _{CM(DC)} (V) | | | V _{DIF(AC)} (V) | |
|---------------------|-----------------------|-----|-------|--------------------------|-----|------------------------|-----|------|-------------------------|-----|------|--------------------------|-----|
| | Min | Typ | Max | Min | Max | Min | Typ | Max | Min | Typ | Max | Min | Max |
| HSTL-18 Class I, II | 1.71 | 1.8 | 1.89 | 0.2 | — | 0.78 | — | 1.12 | 0.78 | — | 1.12 | 0.4 | — |
| HSTL-15 Class I, II | 1.425 | 1.5 | 1.575 | 0.2 | — | 0.68 | — | 0.9 | 0.68 | — | 0.9 | 0.4 | — |

Switching Characteristics

This section provides performance characteristics of the Stratix V core and periphery blocks.

These characteristics can be designated as Preliminary or Final.

- Preliminary characteristics are created using simulation results, process data, and other known parameters. The title of these tables show the designation as "Preliminary."
- Final numbers are based on actual silicon characterization and testing. The numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions. There are no designations on finalized tables.

Transceiver Performance Specifications

This section describes transceiver performance specifications.

Table 23 lists the Stratix V GX and GS transceiver specifications.

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 1 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit | |
|--|---|---|-----|-----|------------------------------|-----|-----|------------------------------|-----|-----|------|--|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | | |
| Reference Clock | | | | | | | | | | | | |
| Supported I/O Standards | Dedicated reference clock pin | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL | | | | | | | | | | |
| | RX reference clock pin | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS | | | | | | | | | | |
| Input Reference Clock Frequency (CMU PLL) ⁽⁸⁾ | — | 40 | — | 710 | 40 | — | 710 | 40 | — | 710 | MHz | |
| Input Reference Clock Frequency (ATX PLL) ⁽⁸⁾ | — | 100 | — | 710 | 100 | — | 710 | 100 | — | 710 | MHz | |
| Rise time | Measure at ± 60 mV of differential signal ⁽²⁶⁾ | — | — | 400 | — | — | 400 | — | — | 400 | ps | |
| Fall time | Measure at ± 60 mV of differential signal ⁽²⁶⁾ | — | — | 400 | — | — | 400 | — | — | 400 | | |
| Duty cycle | — | 45 | — | 55 | 45 | — | 55 | 45 | — | 55 | % | |
| Spread-spectrum modulating clock frequency | PCI Express® (PCIe®) | 30 | — | 33 | 30 | — | 33 | 30 | — | 33 | kHz | |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 5 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|--|------------------------------|------------------|-------|------------------------------|------------------|-------|------------------------------|------------------|--------------------------|----------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Programmable DC gain | DC Gain Setting = 0 | — | 0 | — | — | 0 | — | — | 0 | — | dB |
| | DC Gain Setting = 1 | — | 2 | — | — | 2 | — | — | 2 | — | dB |
| | DC Gain Setting = 2 | — | 4 | — | — | 4 | — | — | 4 | — | dB |
| | DC Gain Setting = 3 | — | 6 | — | — | 6 | — | — | 6 | — | dB |
| | DC Gain Setting = 4 | — | 8 | — | — | 8 | — | — | 8 | — | dB |
| Transmitter | | | | | | | | | | | |
| Supported I/O Standards | — | 1.4-V and 1.5-V PCML | | | | | | | | | |
| Data rate (Standard PCS) | — | 600 | — | 12200 | 600 | — | 12200 | 600 | — | 8500/ 10312.5 (24) | Mbps |
| Data rate (10G PCS) | — | 600 | — | 14100 | 600 | — | 12500 | 600 | — | 8500/ 10312.5 (24) | Mbps |
| Differential on- chip termination resistors | 85- Ω setting | — | 85 \pm 20% | — | — | 85 \pm 20% | — | — | 85 \pm 20% | — | Ω |
| | 100- Ω setting | — | 100 \pm 20% | — | — | 100 \pm 20% | — | — | 100 \pm 20% | — | Ω |
| | 120- Ω setting | — | 120 \pm 20% | — | — | 120 \pm 20% | — | — | 120 \pm 20% | — | Ω |
| | 150- Ω setting | — | 150 \pm 20% | — | — | 150 \pm 20% | — | — | 150 \pm 20% | — | Ω |
| V _{OCM} (AC coupled) | 0.65-V setting | — | 650 | — | — | 650 | — | — | 650 | — | mV |
| V _{OCM} (DC coupled) | — | — | 650 | — | — | 650 | — | — | 650 | — | mV |
| Rise time ⁽⁷⁾ | 20% to 80% | 30 | — | 160 | 30 | — | 160 | 30 | — | 160 | ps |
| Fall time ⁽⁷⁾ | 80% to 20% | 30 | — | 160 | 30 | — | 160 | 30 | — | 160 | ps |
| Intra-differential pair skew | Tx V _{CM} = 0.5 V and slew rate of 15 ps | — | — | 15 | — | — | 15 | — | — | 15 | ps |
| Intra-transceiver block transmitter channel-to- channel skew | x6 PMA bonded mode | — | — | 120 | — | — | 120 | — | — | 120 | ps |

Table 23. Transceiver Specifications for Stratix V GX and GS Devices ⁽¹⁾ (Part 6 of 7)

| Symbol/ Description | Conditions | Transceiver Speed Grade 1 | | | Transceiver Speed Grade 2 | | | Transceiver Speed Grade 3 | | | Unit |
|---|--|------------------------------|-----|-------------------------------|------------------------------|-----|-------------------------------|------------------------------|-----|-------------------------------------|------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Inter-transceiver block transmitter channel-to- channel skew | xN PMA bonded mode | — | — | 500 | — | — | 500 | — | — | 500 | ps |
| CMU PLL | | | | | | | | | | | |
| Supported Data Range | — | 600 | — | 12500 | 600 | — | 12500 | 600 | — | 8500/ 10312.5 ⁽²⁴⁾ | Mbps |
| $t_{pll_powerdown}$ ⁽¹⁵⁾ | — | 1 | — | — | 1 | — | — | 1 | — | — | μs |
| t_{pll_lock} ⁽¹⁶⁾ | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| ATX PLL | | | | | | | | | | | |
| Supported Data Rate Range | VCO post-divider L=2 | 8000 | — | 14100 | 8000 | — | 12500 | 8000 | — | 8500/ 10312.5 ⁽²⁴⁾ | Mbps |
| | L=4 | 4000 | — | 7050 | 4000 | — | 6600 | 4000 | — | 6600 | Mbps |
| | L=8 | 2000 | — | 3525 | 2000 | — | 3300 | 2000 | — | 3300 | Mbps |
| | L=8, Local/Central Clock Divider =2 | 1000 | — | 1762.5 | 1000 | — | 1762.5 | 1000 | — | 1762.5 | Mbps |
| | $t_{pll_powerdown}$ ⁽¹⁵⁾ | — | 1 | — | — | 1 | — | — | 1 | — | — |
| t_{pll_lock} ⁽¹⁶⁾ | — | — | — | 10 | — | — | 10 | — | — | 10 | μs |
| fPLL | | | | | | | | | | | |
| Supported Data Range | — | 600 | — | 3250/ 3125 ⁽²⁵⁾ | 600 | — | 3250/ 3125 ⁽²⁵⁾ | 600 | — | 3250/ 3125 ⁽²⁵⁾ | Mbps |
| $t_{pll_powerdown}$ ⁽¹⁵⁾ | — | 1 | — | — | 1 | — | — | 1 | — | — | μs |

Table 27 shows the V_{OD} settings for the GX channel.

Table 27. Typical V_{OD} Setting for GX Channel, TX Termination = 100 Ω⁽²⁾

| Symbol | V _{OD} Setting | V _{OD} Value (mV) | V _{OD} Setting | V _{OD} Value (mV) |
|--|-------------------------|----------------------------|-------------------------|----------------------------|
| V _{OD} differential peak to peak typical ⁽³⁾ | 0 ⁽¹⁾ | 0 | 32 | 640 |
| | 1 ⁽¹⁾ | 20 | 33 | 660 |
| | 2 ⁽¹⁾ | 40 | 34 | 680 |
| | 3 ⁽¹⁾ | 60 | 35 | 700 |
| | 4 ⁽¹⁾ | 80 | 36 | 720 |
| | 5 ⁽¹⁾ | 100 | 37 | 740 |
| | 6 | 120 | 38 | 760 |
| | 7 | 140 | 39 | 780 |
| | 8 | 160 | 40 | 800 |
| | 9 | 180 | 41 | 820 |
| | 10 | 200 | 42 | 840 |
| | 11 | 220 | 43 | 860 |
| | 12 | 240 | 44 | 880 |
| | 13 | 260 | 45 | 900 |
| | 14 | 280 | 46 | 920 |
| | 15 | 300 | 47 | 940 |
| | 16 | 320 | 48 | 960 |
| | 17 | 340 | 49 | 980 |
| | 18 | 360 | 50 | 1000 |
| | 19 | 380 | 51 | 1020 |
| | 20 | 400 | 52 | 1040 |
| | 21 | 420 | 53 | 1060 |
| | 22 | 440 | 54 | 1080 |
| | 23 | 460 | 55 | 1100 |
| | 24 | 480 | 56 | 1120 |
| | 25 | 500 | 57 | 1140 |
| | 26 | 520 | 58 | 1160 |
| | 27 | 540 | 59 | 1180 |
| | 28 | 560 | 60 | 1200 |
| | 29 | 580 | 61 | 1220 |
| | 30 | 600 | 62 | 1240 |
| | 31 | 620 | 63 | 1260 |

Note to Table 27:

- (1) If TX termination resistance = 100Ω, this VOD setting is illegal.
- (2) The tolerance is +/-20% for all VOD settings except for settings 2 and below.
- (3) Refer to Figure 2.

Figure 4 shows the differential transmitter output waveform.

Figure 4. Differential Transmitter/Receiver Output/Input Waveform

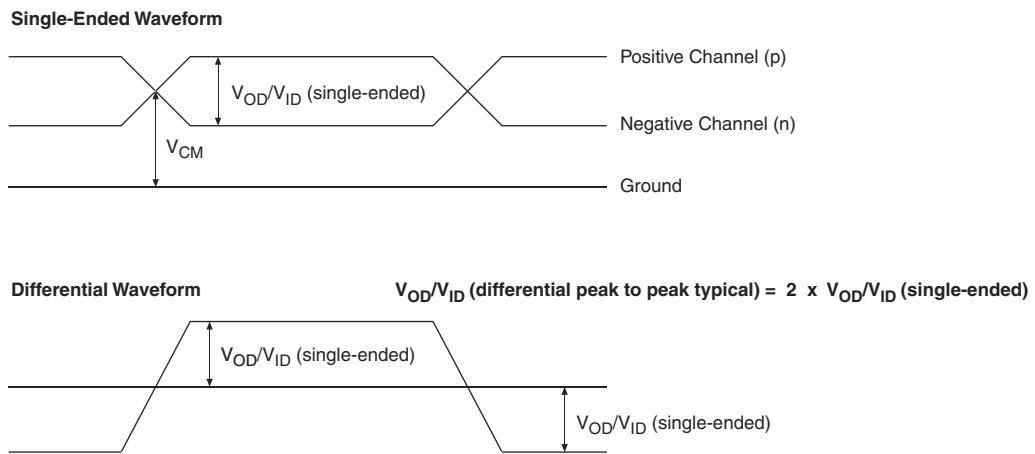


Figure 5 shows the Stratix V AC gain curves for GT channels.

Figure 5. AC Gain Curves for GT Channels

- XFI
- ASI
- HiGig/HiGig+
- HiGig2/HiGig2+
- Serial Data Converter (SDC)
- GPON
- SDI
- SONET
- Fibre Channel (FC)
- PCIe
- QPI
- SFF-8431

Download the Stratix V Characterization Report Tool to view the characterization report summary for these protocols.

Core Performance Specifications

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), memory blocks, configuration, and JTAG specifications.

Clock Tree Specifications

Table 30 lists the clock tree specifications for Stratix V devices.

Table 30. Clock Tree Performance for Stratix V Devices ⁽¹⁾

| Symbol | Performance | | | Unit |
|---------------------------|--------------------------|-----------------------|--------|------|
| | C1, C2, C2L, I2, and I2L | C3, I3, I3L, and I3YY | C4, I4 | |
| Global and Regional Clock | 717 | 650 | 580 | MHz |
| Periphery Clock | 550 | 500 | 500 | MHz |

Note to Table 30:

(1) The Stratix V ES devices are limited to 600 MHz core clock tree performance.

Table 31. PLL Specifications for Stratix V Devices (Part 3 of 3)

| Symbol | Parameter | Min | Typ | Max | Unit |
|-----------|--|--------|------|-------|------|
| f_{RES} | Resolution of VCO frequency ($f_{INPFD} = 100$ MHz) | 390625 | 5.96 | 0.023 | Hz |

Notes to Table 31:

- (1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (2) This specification is limited by the lower of the two: I/O f_{MAX} or f_{OUT} of the PLL.
- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source < 120 ps.
- (4) f_{REF} is f_{IN}/N when $N = 1$.
- (5) Peak-to-peak jitter with a probability level of 10^{-12} (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in Table 44 on page 52.
- (6) The cascaded PLL specification is only applicable with the following condition:
 - a. Upstream PLL: $0.59\text{MHz} \leq \text{Upstream PLL BW} < 1$ MHz
 - b. Downstream PLL: Downstream PLL BW > 2 MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) The external memory interface clock output jitter specifications use a different measurement method, which is available in Table 42 on page 50.
- (9) The VCO frequency reported by the Quartus II software in the PLL Usage Summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the f_{VCO} specification.
- (10) This specification only covers fractional PLL for low bandwidth. The f_{VCO} for fractional value range 0.05 - 0.95 must be ≥ 1000 MHz, while f_{VCO} for fractional value range 0.20 - 0.80 must be ≥ 1200 MHz.
- (11) This specification only covered fractional PLL for low bandwidth. The f_{VCO} for fractional value range 0.05-0.95 must be ≥ 1000 MHz.
- (12) This specification only covered fractional PLL for low bandwidth. The f_{VCO} for fractional value range 0.20-0.80 must be ≥ 1200 MHz.

DSP Block Specifications

Table 32 lists the Stratix V DSP block performance specifications.

Table 32. Block Performance Specifications for Stratix V DSP Devices (Part 1 of 2)

| Mode | Performance | | | | | | | Unit |
|--|-------------|---------|---------|-----|------------------|-----|-----|------|
| | C1 | C2, C2L | I2, I2L | C3 | I3, I3L, I3YY | C4 | I4 | |
| Modes using one DSP | | | | | | | | |
| Three 9 x 9 | 600 | 600 | 600 | 480 | 480 | 420 | 420 | MHz |
| One 18 x 18 | 600 | 600 | 600 | 480 | 480 | 420 | 400 | MHz |
| Two partial 18 x 18 (or 16 x 16) | 600 | 600 | 600 | 480 | 480 | 420 | 400 | MHz |
| One 27 x 27 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| One 36 x 18 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| One sum of two 18 x 18(One sum of 2 16 x 16) | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| One sum of square | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| One 18 x 18 plus 36 (a x b) + c | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| Modes using two DSPs | | | | | | | | |
| Three 18 x 18 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| One sum of four 18 x 18 | 475 | 475 | 475 | 380 | 380 | 300 | 300 | MHz |
| One sum of two 27 x 27 | 465 | 465 | 450 | 380 | 380 | 300 | 290 | MHz |
| One sum of two 36 x 18 | 475 | 475 | 475 | 380 | 380 | 300 | 300 | MHz |
| One complex 18 x 18 | 500 | 500 | 500 | 400 | 400 | 350 | 350 | MHz |
| One 36 x 36 | 475 | 475 | 475 | 380 | 380 | 300 | 300 | MHz |

Table 33. Memory Block Performance Specifications for Stratix V Devices⁽¹⁾, ⁽²⁾ (Part 2 of 2)

| Memory | Mode | Resources Used | | Performance | | | | | | | Unit |
|---------------|--|----------------|--------|-------------|------------|-----|-----|---------|---------------------|-----|------|
| | | ALUTs | Memory | C1 | C2, C2L | C3 | C4 | I2, I2L | I3, I3L, I3YY | I4 | |
| M20K Block | Single-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | Simple dual-port with the read-during-write option set to Old Data , all supported widths | 0 | 1 | 525 | 525 | 455 | 400 | 525 | 455 | 400 | MHz |
| | Simple dual-port with ECC enabled, 512 × 32 | 0 | 1 | 450 | 450 | 400 | 350 | 450 | 400 | 350 | MHz |
| | Simple dual-port with ECC and optional pipeline registers enabled, 512 × 32 | 0 | 1 | 600 | 600 | 500 | 450 | 600 | 500 | 450 | MHz |
| | True dual port, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |
| | ROM, all supported widths | 0 | 1 | 700 | 700 | 650 | 550 | 700 | 500 | 450 | MHz |

Notes to Table 33:

- (1) To achieve the maximum memory block performance, use a memory block clock that comes through global clock routing from an on-chip PLL set to **50%** output duty cycle. Use the Quartus II software to report timing for this and other memory block clocking schemes.
- (2) When you use the error detection cyclical redundancy check (CRC) feature, there is no degradation in F_{MAX} .
- (3) The F_{MAX} specification is only achievable with Fitter options, **MLAB Implementation In 16-Bit Deep Mode** enabled.

Temperature Sensing Diode Specifications

Table 34 lists the internal TSD specification.

Table 34. Internal Temperature Sensing Diode Specification

| Temperature Range | Accuracy | Offset Calibrated Option | Sampling Rate | Conversion Time | Resolution | Minimum Resolution with no Missing Codes |
|-------------------|----------|--------------------------|----------------|-----------------|------------|--|
| –40°C to 100°C | ±8°C | No | 1 MHz, 500 KHz | < 100 ms | 8 bits | 8 bits |

Table 35 lists the specifications for the Stratix V external temperature sensing diode.

Table 35. External Temperature Sensing Diode Specifications for Stratix V Devices

| Description | Min | Typ | Max | Unit |
|-----------------------------------|-------|-------|-------|------|
| I_{bias} , diode source current | 8 | — | 200 | μA |
| V_{bias} , voltage across diode | 0.3 | — | 0.9 | V |
| Series resistance | — | — | < 1 | Ω |
| Diode ideality factor | 1.006 | 1.008 | 1.010 | — |

Table 36. High-Speed I/O Specifications for Stratix V Devices⁽¹⁾, ⁽²⁾ (Part 2 of 4)

| Symbol | Conditions | C1 | | | C2, C2L, I2, I2L | | | C3, I3, I3L, I3YY | | | C4,I4 | | | Unit |
|---|--|------------|------------|------------|-------------------------|------------|------------|--------------------------|------------|------------|--------------|------------|------------|-------------|
| | | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max | |
| Transmitter | | | | | | | | | | | | | | |
| True Differential I/O Standards - f_{HSDR} (data rate) | SERDES factor J = 3 to 10 ^{(9), (11), (12), (13), (14), (15), (16)} | (6) | — | 1600 | (6) | — | 1434 | (6) | — | 1250 | (6) | — | 1050 | Mbps |
| | SERDES factor J ≥ 4 LVDS TX with DPA ^{(12), (14), (15), (16)} | (6) | — | 1600 | (6) | — | 1600 | (6) | — | 1600 | (6) | — | 1250 | Mbps |
| | SERDES factor J = 2, uses DDR Registers | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| | SERDES factor J = 1, uses SDR Register | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | (6) | — | (7) | Mbps |
| Emulated Differential I/O Standards with Three External Output Resistor Networks - f_{HSDR} (data rate) ⁽¹⁰⁾ | SERDES factor J = 4 to 10 ⁽¹⁷⁾ | (6) | — | 1100 | (6) | — | 1100 | (6) | — | 840 | (6) | — | 840 | Mbps |
| $t_{x\text{Jitter}}$ - True Differential I/O Standards | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | — | — | 160 | — | — | 160 | — | — | 160 | — | — | 160 | ps |
| | Total Jitter for Data Rate < 600 Mbps | — | — | 0.1 | — | — | 0.1 | — | — | 0.1 | — | — | 0.1 | UI |
| Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | Total Jitter for Data Rate 600 Mbps - 1.25 Gbps | — | — | 300 | — | — | 300 | — | — | 300 | — | — | 325 | ps |
| | Total Jitter for Data Rate < 600 Mbps | — | — | 0.2 | — | — | 0.2 | — | — | 0.2 | — | — | 0.25 | UI |

Table 46. JTAG Timing Parameters and Values for Stratix V Devices

| Symbol | Description | Min | Max | Unit |
|-------------------|--|------------|-------------------|-------------|
| t _{JPH} | JTAG port hold time | 5 | — | ns |
| t _{JPCO} | JTAG port clock to output | — | 11 ⁽¹⁾ | ns |
| t _{JPXZ} | JTAG port high impedance to valid output | — | 14 ⁽¹⁾ | ns |
| t _{JPXZ} | JTAG port valid output to high impedance | — | 14 ⁽¹⁾ | ns |

Notes to Table 46:

- (1) A 1 ns adder is required for each V_{CCIO} voltage step down from 3.0 V. For example, t_{JPCO} = 12 ns if V_{CCIO} of the TDO I/O bank = 2.5 V, or 13 ns if it equals 1.8 V.
- (2) The minimum TCK clock period is 167 ns if VCCBAT is within the range 1.2V-1.5V when you perform the volatile key programming.

Raw Binary File Size

For the POR delay specification, refer to the “POR Delay Specification” section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices”.

Table 47 lists the uncompressed raw binary file (.rbf) sizes for Stratix V devices.

Table 47. Uncompressed .rbf Sizes for Stratix V Devices

| Family | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) ^{(4), (5)} |
|---------------|---------------|------------------------------|---------------------------------------|---|
| Stratix V GX | 5SGXA3 | H35, F40, F35 ⁽²⁾ | 213,798,880 | 562,392 |
| | | H29, F35 ⁽³⁾ | 137,598,880 | 564,504 |
| | 5SGXA4 | — | 213,798,880 | 563,672 |
| | 5SGXA5 | — | 269,979,008 | 562,392 |
| | 5SGXA7 | — | 269,979,008 | 562,392 |
| | 5SGXA9 | — | 342,742,976 | 700,888 |
| | 5SGXAB | — | 342,742,976 | 700,888 |
| | 5SGXB5 | — | 270,528,640 | 584,344 |
| | 5SGXB6 | — | 270,528,640 | 584,344 |
| | 5SGXB9 | — | 342,742,976 | 700,888 |
| | 5SGXBB | — | 342,742,976 | 700,888 |
| Stratix V GT | 5SGTC5 | — | 269,979,008 | 562,392 |
| | 5SGTC7 | — | 269,979,008 | 562,392 |
| Stratix V GS | 5SGSD3 | — | 137,598,880 | 564,504 |
| | 5SGSD4 | F1517 | 213,798,880 | 563,672 |
| | | — | 137,598,880 | 564,504 |
| | 5SGSD5 | — | 213,798,880 | 563,672 |
| | 5SGSD6 | — | 293,441,888 | 565,528 |
| | 5SGSD8 | — | 293,441,888 | 565,528 |

Table 49. DCLK-to-DATA[] Ratio ⁽¹⁾ (Part 2 of 2)

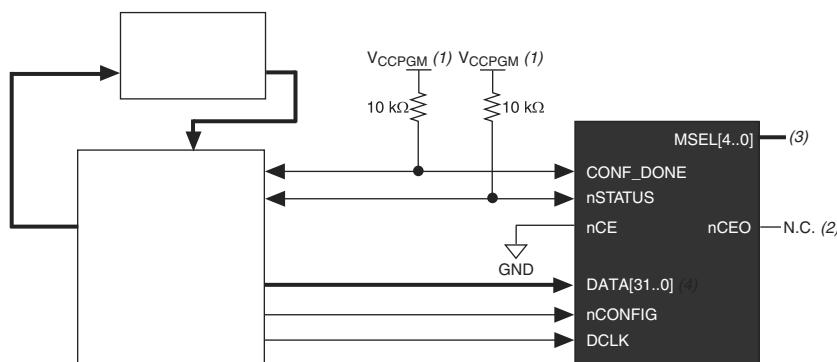
| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|-----------------------------|----------------------|------------------------|-----------------------------|
| FPP ×32 | Disabled | Disabled | 1 |
| | Disabled | Enabled | 4 |
| | Enabled | Disabled | 8 |
| | Enabled | Enabled | 8 |

Note to Table 49:

- (1) Depending on the DCLK-to-DATA[] ratio, the host must send a DCLK frequency that is r times the data rate in bytes per second (Bps), or words per second (Wps). For example, in FPP ×16 when the DCLK-to-DATA[] ratio is 2, the DCLK frequency must be 2 times the data rate in Wps. Stratix V devices use the additional clock cycles to decrypt and decompress the configuration data.

 If the DCLK-to-DATA[] ratio is greater than 1, at the end of configuration, you can only stop the DCLK (DCLK-to-DATA[] ratio – 1) clock cycles after the last data is latched into the Stratix V device.

Figure 11 shows the configuration interface connections between the Stratix V device and a MAX II or MAX V device for single device configuration.

Figure 11. Single Device FPP Configuration Using an External Host**Notes to Figure 11:**

- (1) Connect the resistor to a supply that provides an acceptable input signal for the Stratix V device. V_{CCPGM} must be high enough to meet the V_{IH} specification of the I/O on the device and the external host. Altera recommends powering up all configuration system I/Os with V_{CCPGM} .
- (2) You can leave the nCEO pin unconnected or use it as a user I/O pin when it does not feed another device's nCE pin.
- (3) The MSEL pin settings vary for different data width, configuration voltage standards, and POR delay. To connect MSEL, refer to the MSEL Pin Settings section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (4) If you use FPP ×8, use DATA [7..0]. If you use FPP ×16, use DATA [15..0].

Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is 1.

Table 50. FPP Timing Parameters for Stratix V Devices⁽¹⁾

| Symbol | Parameter | Minimum | Maximum | Units |
|-------------------|---|--|----------------------|-------|
| t_{CF2CD} | nCONFIG low to CONF_DONE low | — | 600 | ns |
| t_{CF2ST0} | nCONFIG low to nSTATUS low | — | 600 | ns |
| t_{CFG} | nCONFIG low pulse width | 2 | — | μs |
| t_{STATUS} | nSTATUS low pulse width | 268 | 1,506 ⁽²⁾ | μs |
| t_{CF2ST1} | nCONFIG high to nSTATUS high | — | 1,506 ⁽³⁾ | μs |
| $t_{CF2CK}^{(6)}$ | nCONFIG high to first rising edge on DCLK | 1,506 | — | μs |
| $t_{ST2CK}^{(6)}$ | nSTATUS high to first rising edge of DCLK | 2 | — | μs |
| t_{DSU} | DATA [] setup time before rising edge on DCLK | 5.5 | — | ns |
| t_{DH} | DATA [] hold time after rising edge on DCLK | 0 | — | ns |
| t_{CH} | DCLK high time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CL} | DCLK low time | $0.45 \times 1/f_{MAX}$ | — | s |
| t_{CLK} | DCLK period | $1/f_{MAX}$ | — | s |
| f_{MAX} | DCLK frequency (FPP ×8/×16) | — | 125 | MHz |
| | DCLK frequency (FPP ×32) | — | 100 | MHz |
| t_{CD2UM} | CONF_DONE high to user mode ⁽⁴⁾ | 175 | 437 | μs |
| t_{CD2CU} | CONF_DONE high to CLKUSR enabled | $4 \times$ maximum DCLK period | — | — |
| t_{CD2UMC} | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} +$ $(8576 \times$ CLKUSR period) ⁽⁵⁾ | — | — |

Notes to Table 50:

- (1) Use these timing parameters when the decompression and design security features are disabled.
- (2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (6) If nSTATUS is monitored, follow the t_{ST2CK} specification. If nSTATUS is not monitored, follow the t_{CF2CK} specification.

FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.

Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

Table 56. Remote System Upgrade Circuitry Timing Specifications

| Parameter | Minimum | Maximum | Unit |
|-----------------------------|---------|---------|------|
| trU_nCONFIG ⁽¹⁾ | 250 | — | ns |
| trU_nRSTIMER ⁽²⁾ | 250 | — | ns |

Notes to Table 56:

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (2) This is equivalent to strobing the reset_timer input of the ALTREMOTE_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

Table 57. 12.5-MHz Internal Oscillator Specifications

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3 | 7.9 | 12.5 | MHz |

I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.

- You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)

| Parameter ⁽¹⁾ | Available Settings | Min Offset ⁽²⁾ | Fast Model | | Slow Model | | | | | | | |
|-----------------------------|-----------------------|---------------------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|----|
| | | | Industrial | Commercial | C1 | C2 | C3 | C4 | I2 | I3, I3YY | | |
| D1 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D2 | 32 | 0 | 0.230 | 0.244 | 0.415 | 0.415 | 0.459 | 0.503 | 0.417 | 0.456 | 0.500 | ns |

Table 58. IOE Programmable Delay for Stratix V Devices (Part 2 of 2)

| Parameter (1) | Available Settings | Min Offset (2) | Fast Model | | Slow Model | | | | | | | |
|--------------------------|-------------------------------|-------------------------------|-------------------|-------------------|-------------------|-----------|-----------|-----------|-----------|---------------------|-----------|-------------|
| | | | Industrial | Commercial | C1 | C2 | C3 | C4 | I2 | I3, I3YY | I4 | Unit |
| D3 | 8 | 0 | 1.587 | 1.699 | 2.793 | 2.793 | 2.992 | 3.192 | 2.811 | 3.047 | 3.257 | ns |
| D4 | 64 | 0 | 0.464 | 0.492 | 0.838 | 0.838 | 0.924 | 1.011 | 0.843 | 0.920 | 1.006 | ns |
| D5 | 64 | 0 | 0.464 | 0.493 | 0.838 | 0.838 | 0.924 | 1.011 | 0.844 | 0.921 | 1.006 | ns |
| D6 | 32 | 0 | 0.229 | 0.244 | 0.415 | 0.415 | 0.458 | 0.503 | 0.418 | 0.456 | 0.499 | ns |

Notes to Table 58:

- (1) You can set this value in the Quartus II software by selecting **D1**, **D2**, **D3**, **D5**, and **D6** in the **Assignment Name** column of **Assignment Editor**.
(2) Minimum offset does not include the intrinsic delay.

Programmable Output Buffer Delay

Table 59 lists the delay chain settings that control the rising and falling edge delays of the output buffer. The default delay is 0 ps.

Table 59. Programmable Output Buffer Delay for Stratix V Devices (1)

| Symbol | Parameter | Typical | Unit |
|---------------|----------------------------------|----------------|-------------|
| D_{OUTBUF} | Rising and/or falling edge delay | 0 (default) | ps |
| | | 25 | ps |
| | | 50 | ps |
| | | 75 | ps |

Note to Table 59:

- (1) You can set the programmable output buffer delay in the Quartus II software by setting the **Output Buffer Delay Control** assignment to either positive, negative, or both edges, with the specific values stated here (in ps) for the **Output Buffer Delay** assignment.

Glossary

Table 60 lists the glossary for this chapter.

Table 60. Glossary (Part 1 of 4)

| Letter | Subject | Definitions |
|---------------|----------------|--|
| A | — | — |
| B | — | — |
| C | — | — |
| D | — | — |
| E | — | — |
| F | f_{HSCLK} | Left and right PLL input clock frequency. |
| | f_{HSDR} | High-speed I/O block—Maximum and minimum LVDS data transfer rate ($f_{HSDR} = 1/TUI$), non-DPA. |
| | $f_{HSDRDPA}$ | High-speed I/O block—Maximum and minimum LVDS data transfer rate ($f_{HSDRDPA} = 1/TUI$), DPA. |

Table 61. Document Revision History (Part 2 of 3)

| Date | Version | Changes |
|---------------|---------|--|
| November 2014 | 3.3 | <ul style="list-style-type: none"> ■ Added the I3YY speed grade and changed the data rates for the GX channel in Table 1. ■ Added the I3YY speed grade to the V_{CC} description in Table 6. ■ Added the I3YY speed grade to V_{CCHIP_L}, V_{CCHIP_R}, V_{CCHSSI_L}, and V_{CCHSSI_R} descriptions in Table 7. ■ Added 240-Ω to Table 11. ■ Changed CDR PPM tolerance in Table 23. ■ Added additional max data rate for fPLL in Table 23. ■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 25. ■ Added the I3YY speed grade and changed the data rates for transceiver speed grade 3 in Table 26. ■ Changed CDR PPM tolerance in Table 28. ■ Added additional max data rate for fPLL in Table 28. ■ Changed the mode descriptions for MLAB and M20K in Table 33. ■ Changed the Max value of f_{HSCLK_OUT} for the C2, C2L, I2, I2L speed grades in Table 36. ■ Changed the frequency ranges for C1 and C2 in Table 39. ■ Changed the .rbf file sizes for 5SGSD6 and 5SGSD8 in Table 47. ■ Added note about nSTATUS to Table 50, Table 51, Table 54. ■ Changed the available settings in Table 58. ■ Changed the note in “Periphery Performance”. ■ Updated the “I/O Standard Specifications” section. ■ Updated the “Raw Binary File Size” section. ■ Updated the receiver voltage input range in Table 22. ■ Updated the max frequency for the LVDS clock network in Table 36. ■ Updated the DCLK note to Figure 11. ■ Updated Table 23 VO_{CM} (DC Coupled) condition. ■ Updated Table 6 and Table 7. ■ Added the DCLK specification to Table 55. ■ Updated the notes for Table 47. ■ Updated the list of parameters for Table 56. |
| November 2013 | 3.2 | <ul style="list-style-type: none"> ■ Updated Table 28 |
| November 2013 | 3.1 | <ul style="list-style-type: none"> ■ Updated Table 33 |
| November 2013 | 3.0 | <ul style="list-style-type: none"> ■ Updated Table 23 and Table 28 |
| October 2013 | 2.9 | <ul style="list-style-type: none"> ■ Updated the “Transceiver Characterization” section |
| October 2013 | 2.8 | <ul style="list-style-type: none"> ■ Updated Table 3, Table 12, Table 14, Table 19, Table 20, Table 23, Table 24, Table 28, Table 30, Table 31, Table 32, Table 33, Table 36, Table 39, Table 40, Table 41, Table 42, Table 47, Table 53, Table 58, and Table 59 ■ Added Figure 1 and Figure 3 ■ Added the “Transceiver Characterization” section ■ Removed all “Preliminary” designations. |

Table 61. Document Revision History (Part 3 of 3)

| Date | Version | Changes |
|---------------|---------|--|
| May 2013 | 2.7 | <ul style="list-style-type: none"> ■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60 ■ Added Table 24, Table 48 ■ Updated Figure 9, Figure 10, Figure 11, Figure 12 |
| February 2013 | 2.6 | <ul style="list-style-type: none"> ■ Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46 ■ Updated “Maximum Allowed Overshoot and Undershoot Voltage” |
| December 2012 | 2.5 | <ul style="list-style-type: none"> ■ Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35 ■ Added Table 33 ■ Added “Fast Passive Parallel Configuration Timing” ■ Added “Active Serial Configuration Timing” ■ Added “Passive Serial Configuration Timing” ■ Added “Remote System Upgrades” ■ Added “User Watchdog Internal Circuitry Timing Specification” ■ Added “Initialization” ■ Added “Raw Binary File Size” |
| June 2012 | 2.4 | <ul style="list-style-type: none"> ■ Added Figure 1, Figure 2, and Figure 3. ■ Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27, Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59. ■ Various edits throughout to fix bugs. ■ Changed title of document to <i>Stratix V Device Datasheet</i>. ■ Removed document from the Stratix V handbook and made it a separate document. |
| February 2012 | 2.3 | <ul style="list-style-type: none"> ■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31. |
| December 2011 | 2.2 | <ul style="list-style-type: none"> ■ Added Table 2–31. ■ Updated Table 2–28 and Table 2–34. |
| November 2011 | 2.1 | <ul style="list-style-type: none"> ■ Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices. ■ Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25. ■ Various edits throughout to fix SPRs. |
| May 2011 | 2.0 | <ul style="list-style-type: none"> ■ Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24. ■ Updated the “DQ Logic Block and Memory Output Clock Jitter Specifications” title. ■ Chapter moved to Volume 1. ■ Minor text edits. |
| December 2010 | 1.1 | <ul style="list-style-type: none"> ■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23. ■ Converted chapter to the new template. ■ Minor text edits. |
| July 2010 | 1.0 | Initial release. |

